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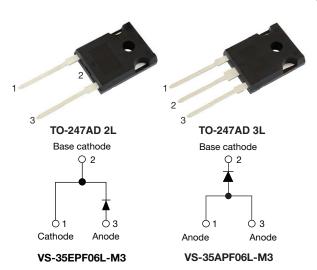
Vishay Semiconductors

RoHS

COMPLIANT HALOGEN

**FREE** 

# Fast Soft Recovery Rectifier Diode, 35 A



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	35 A				
$V_{R}$	600 V				
V <sub>F</sub> at I <sub>F</sub>	1.27 V				
I <sub>FSM</sub>	320 A				
t <sub>rr</sub>	60 ns				
T <sub>J</sub> max.	150 °C				
Snap factor	0.6				
Package	TO-247AD 2L, TO-247AD 3L				
Circuit configuration	Single				

#### **FEATURES**

- Very low forward voltage drop and short reverse recovery time
- Glass passivated pellet chip junction
- Designed and qualified according to JEDEC® - JESD 47
- Flexible solution for reliable AC power rectification
- High surge, low V<sub>F</sub> rugged blocking diode for DC charging stations
- AEC-Q101 qualified P/N available (VS-35EPF06LHM3, VS-35APF06LHM3)
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### **APPLICATIONS**

These devices are intended for use in output rectification and freewheeling in inverters, choppers and converters as well as in input rectification where severe restrictions on conducted EMI should be met.

#### **DESCRIPTION**

The VS-35EPF06L-M3 and VS-30APF06L-M3 soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I <sub>F(AV)</sub>	Sinusoidal waveform	35	А			
V <sub>RRM</sub>		600	V			
I <sub>FSM</sub>		320	А			
V <sub>F</sub>	15 A, T <sub>J</sub> = 25 °C	1.27	V			
t <sub>rr</sub>	1 A, 100 A /µs	60	ns			
TJ		-40 to +150	°C			

VOLTAGE RATINGS					
PART NUMBER  V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V  V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE VOLTAGE V  mA					
VS-35EPF06L-M3	600	700	6		
VS-35APF06L-M3	600	700	ð		

# **VS-35EPF06L-M3, VS-35APF06L-M3**

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum average forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 103 °C, 180° conduction half sine wave	35			
Maximum peak one cycle	1	10 ms sine pulse, rated V <sub>RRM</sub> applied	270	Α		
non-repetitive surge current	IFSM	10 ms sine pulse, no voltage reapplied	320			
Maximum I <sup>2</sup> t for fusing	I <sup>2</sup> t	10 ms sine pulse, rated V <sub>RRM</sub> applied	365	A <sup>2</sup> s		
waxiinum i-t for fusing	1-1	10 ms sine pulse, no voltage reapplied 515		A-5		
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	t = 0.1 ms to 10 ms, no voltage reapplied	5150	A²√s		

ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL TEST CONDITIONS VALUES UNITS				UNITS	
Maximum forward voltage drop	$V_{FM}$	35 A, T <sub>J</sub> = 25 °C		1.46	V	
Forward slope resistance	r <sub>t</sub>	T <sub>.1</sub> = 150 °C		12.5	mΩ	
Threshold voltage	V <sub>F(TO)</sub>	1J = 150 C		0.90	V	
Maximum rayaraa laakaga ayrrant	1	T <sub>J</sub> = 25 °C	V <sub>B</sub> = rated V <sub>BBM</sub>	0.1	mA	
Maximum reverse leakage current	I <sub>RM</sub>	T <sub>J</sub> = 150 °C	VR = rated VRRM	6	TIMA	

RECOVERY CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	· •	
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> at 20 A <sub>pk</sub>	160	ns	I <sub>FM</sub> t	
Reverse recovery current	I <sub>rr</sub>	100 A/μs	10	Α	$t_a \mid t_b$	
Reverse recovery charge	Q <sub>rr</sub>	25 °C	1.25	μC	dir/ dt Q <sub>rr</sub>	
Snap factor	S	Typical	0.6		I <sub>RM(REC)</sub>	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL TEST CONDITIONS		VALUES	UNITS	
Maximum junction and stemperature range	storage	T <sub>J</sub> , T <sub>Stg</sub>		-40 to +150	°C	
Maximum thermal resistance, unction to case		R <sub>thJC</sub>	DC operation	0.6		
Maximum thermal resistance, junction to ambient		R <sub>thJA</sub>		40	°C/W	
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	Mounting surface, smooth, and greased	0.25		
A nove vime to weight				6	g	
Approximate weight				0.21	OZ.	
minimum				6 (5)	kgf ⋅ cm	
Mounting torque —	maximum			12 (10) (lbf · in)		
			Case style TO-247AD 2L	35EP	F06L	
Marking device			Case style TO-247AD 3L		35APF06L	



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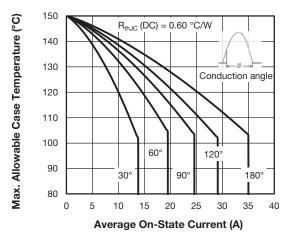


Fig. 1 - Current Rating Characteristics

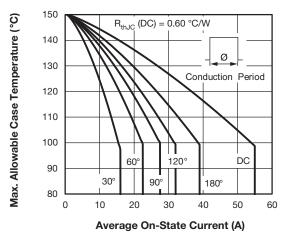


Fig. 2 - Current Rating Characteristics

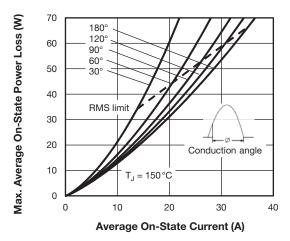


Fig. 3 - Forward Power Loss Characteristics

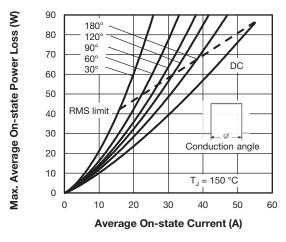


Fig. 4 - Forward Power Loss Characteristics

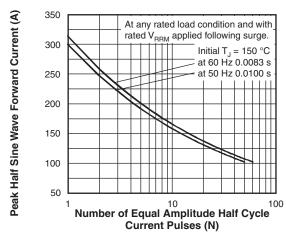


Fig. 5 - Maximum Non-Repetitive Surge Current

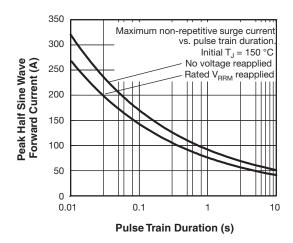


Fig. 6 - Maximum Non-Repetitive Surge Current



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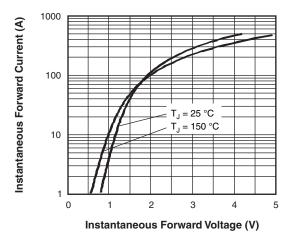


Fig. 7 - Forward Voltage Drop Characteristics

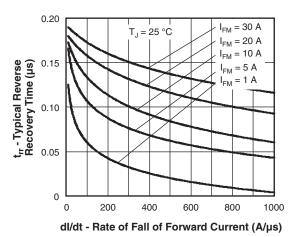


Fig. 8 - Thermal Impedance Z<sub>thJC</sub> Characteristics

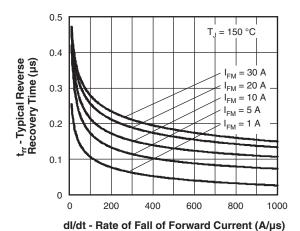


Fig. 9 - Recovery Time Characteristics,  $T_J = 150 \, ^{\circ}\text{C}$ 

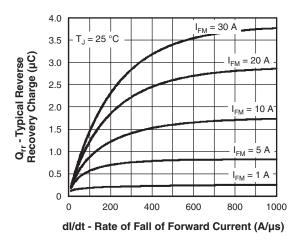


Fig. 10 - Recovery Charge Characteristics,  $T_J = 25$  °C

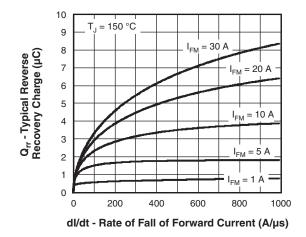


Fig. 11 - Recovery Charge Characteristics,  $T_J = 150 \, ^{\circ}\text{C}$ 

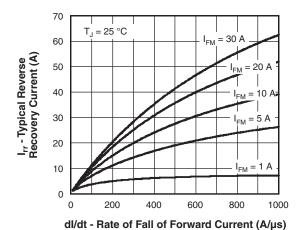


Fig. 12 - Recovery Current Characteristics,  $T_J = 25$  °C



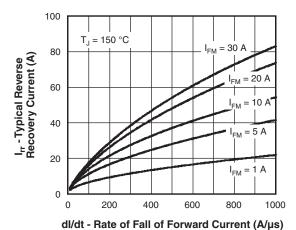


Fig. 13 - Recovery Current Characteristics, T<sub>J</sub> = 150 °C

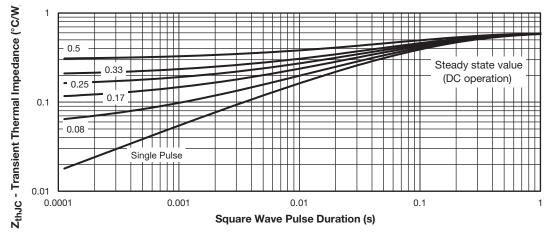


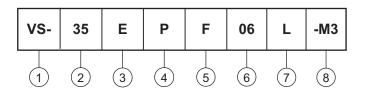
Fig. 14 - Thermal Impedance  $Z_{thJC}$  Characteristics

# VS-35EPF06L-M3, VS-35APF06L-M3

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#### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Current rating (35 = 35 A)

3 - Circuit configuration:

E = single, 2 pins

A = single, 3 pins

4 - Package:

P = TO-247AD

5 - Type of silicon:

F = fast recovery rectifier

6 - Voltage code x 100 = V<sub>RRM</sub> \_\_\_\_\_

06 = 600 V

7 - L = long leads

8 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION						
VS-35EPF06L-M3	25	500	Antistatic plastic tubes			
VS-35APF06L-M3	25	500	Antistatic plastic tubes			

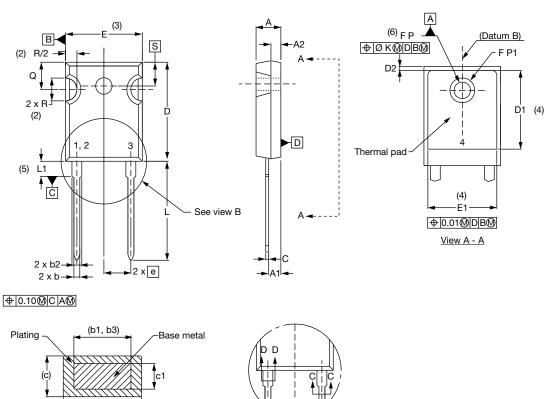
LINKS TO RELATED DOCUMENTS				
Dimensions	TO-247AD 2L	www.vishay.com/doc?95536		
Differsions	TO-247AD 3L	www.vishay.com/doc?95626		
Port marking information	TO-247AD 2L	www.vishay.com/doc?95648		
Part marking information -	TO-247AD 3L	www.vishay.com/doc?95007		



### Vishay Semiconductors

### **TO-247AD 2L**

#### **DIMENSIONS** in millimeters and inches



View B

SYMBOL	MILLIMETERS INCHES		HES	NOTES	
STINIDUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4
D2	0.51	1.35	0.020	0.053	

Section C - C, D - D

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Е	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØK	0.254		0.0	10	
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51	5.51 BSC		BSC	
	•		•	•	

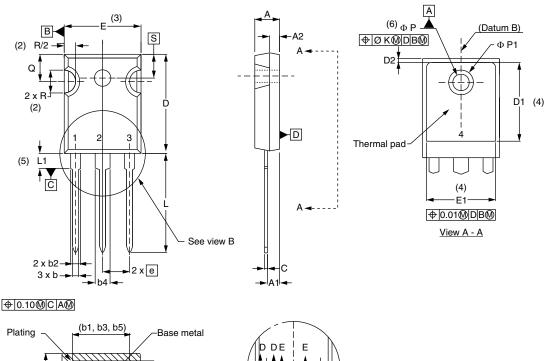
#### **Notes**

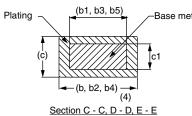
- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4

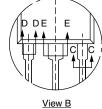
### Vishay Semiconductors

### **TO-247AD 3L**

#### **DIMENSIONS** in millimeters and inches







SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	1	
е	5.46 BSC		0.215 BSC		
ØK	2.54		0.010		
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	1	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		
-	-				

### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
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